

# Designing Ultrafast Loop Response With Type-III Compensation for Current Mode Step-Down Converters

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#### **ABSTRACT**

One of the well-known benefits of current-mode control is that the system stability can be easily achieved by Type-II compensation design. It is possible to improve the transient response of a current mode DC/DC converter by adopting Type-III compensation to boost the crossover frequency and phase margin. Type-III compensation is simple to design and needs only one extra component.

This application report shows a general, step-by-step, Type-III compensation design procedure for current-mode, step-down DC/DC converters as well as a design example using the TPS54620 from the SWIFT™ converter product portfolio.

To simplify design efforts, a complementary design calculator (SLVC219) is available.

#### Contents

	Contents	
1	Introduction	
2	Basic of Compensation Networks	3
3	Design Procedure for Current-Mode Type-III Compensation Networks	4
4	System Performances for Example Design	6
5	Limitations for Current-Mode Type-III Compensation Design Procedure	7
6	Conclusion	8
	List of Figures	
1	TPS54620EVM-374 Schematic (Fsw = 480 kHz)	2
2	Measured Loop Response for TPS54620EVM-374	2
3	Type-II Compensation Networks	
4	Type-III Compensation Networks	3
5	Example Design With Type-III Compensation (Fsw = 480 kHz)	6
6	Measured Loop Response for Example Design	
7	Example Design Transient Response	7
8	TPS54620EVM-374 Transient Response	7
9	Maximum Phase Boost From Type-III Compensation	7
	List of Tables	
1	Frequency Responses and Simplified Pole/Zero Locations	3
2	TPS5/620FVM-37/ Design Parameters	1



Introduction www.ti.com

#### 1 Introduction

The latest generation of SWIFT™ DC/DC converters such as the TPS54418 and TPS54620 families have implemented current-mode control to simplify the external compensation design. Figure 1 from TPS54620EVM-374 6-A, SWIFT™ Regulator Evaluation Module user's guide (SLVU281) shows a typical current-mode design schematic. Figure 2 shows the measured loop-response characteristics at Vin = 12 V and Vout = 3.3 V/6 A.

The resistor R4 and capacitor C4 in Figure 1 determine a typical Type-II compensation network. The overall system is stable with 45-kHz crossover frequency and 46° phase margin. For a general-purpose DC/DC converter, 45-kHz crossover frequency is adequate. In some applications, ultrafast transient response may be required and 100-kHz crossover frequency or higher may be desired. Because the power-stage phase response can drop fast at high frequencies, it is usually difficult to maintain adequate phase margin using Type-II compensation. A Type-III compensation network can be selected as an alternative.

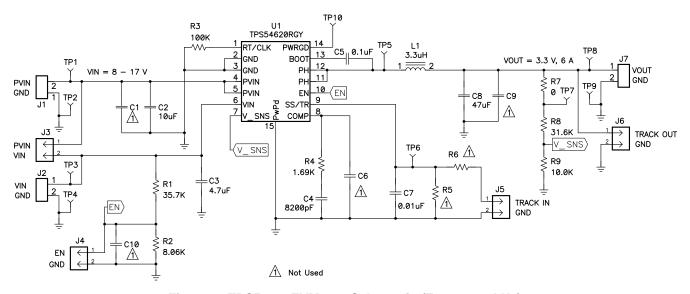


Figure 1. TPS54620EVM-374 Schematic (Fsw = 480 kHz)

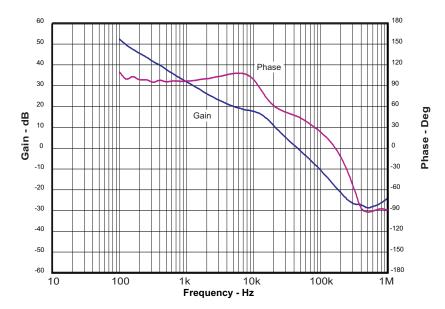


Figure 2. Measured Loop Response for TPS54620EVM-374



## 2 Basic of Compensation Networks

Figure 3 and Figure 4 show commonly used Type-II and Type-III compensation networks. The difference between the Type-2A/2B and the Type-3A/3B circuits is that the Type-2A/3A circuits include an additional high-frequency pole which has been added to attenuate high-frequency noise, when necessary.

The only difference between the Type-2A/2B and Type-3A/3B circuits is the capacitor Cc. This capacitor generates one more zero around the desired crossover frequency, and forms one very-high-frequency pole in the system which is normally ignorable.

Roea and Coea are the equivalent output resistance and output capacitance respectively for the gm error amplifier. The equation for Roea calculation is shown in Table 1. Coea is usually small and can be neglected.

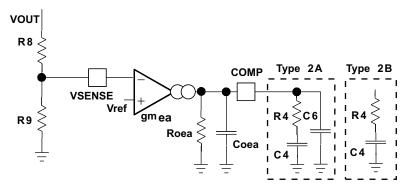


Figure 3. Type-II Compensation Networks

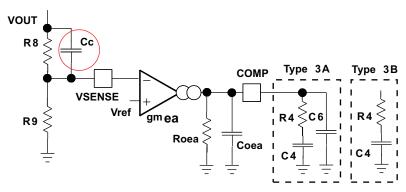


Figure 4. Type-III Compensation Networks

Table 1 provides the frequency responses and simplified pole/zero locations for the compensation networks shown in Figure 3 and Figure 4.

Table 1. Frequency Responses and	d Simplified Pole/Zero Locations
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Compensation	Frequency Responses	Pole/Zero Locations
Type 2A	fp1 fz2 fp3	$f_{p}1 = \frac{1}{2\pi \times \text{Roea} \times \text{C4}}$ $f_{z}2 = \frac{1}{2\pi \times \text{R4} \times \text{C4}}$ $f_{p}3 = \frac{1}{2\pi \times \text{R4} \times \text{C6}}$



Compensation	Frequency Responses	Pole/Zero Locations		
Type 2B	fp1	$f_{p} 1 = \frac{1}{2\pi \times \text{Roea} \times \text{C4}}$ $f_{z} 2 = \frac{1}{2\pi \times \text{R4} \times \text{C4}}$		
Type 3A	fp1 fp5 fp5 fz2 fz3	$f_{p}1 = \frac{1}{2\pi \times \text{Roea} \times \text{C4}}$ $f_{z}2 = \frac{1}{2\pi \times \text{R4} \times \text{C4}}$ $f_{z}3 = \frac{1}{2\pi \times \text{R8} \times \text{Cc}}$ $f_{p}4 = \frac{1}{2\pi \times (\text{R8}/\text{R9}) \times \text{Cc}}$ $f_{p}5 = \frac{1}{2\pi \times \text{R4} \times \text{C6}}$		
Type 3B	fp1 fp4	$f_{p}1 = \frac{1}{2\pi \times \text{Roea} \times \text{C4}}$ $f_{z}2 = \frac{1}{2\pi \times \text{R4} \times \text{C4}}$ $f_{p}3 = \frac{1}{2\pi \times \text{R8} \times \text{Cc}}$ $f_{p}4 = \frac{1}{2\pi \times (\text{R8}//\text{R9}) \times \text{Cc}}$		
Where Roea = $\frac{\text{DCgain}_{\text{ea}}}{\text{gm}_{\text{ea}}}$ , R8 // R9 = $\frac{\text{R8} \times \text{R9}}{\text{R8} + \text{R9}}$				

Table 1. Frequency Responses and Simplified Pole/Zero Locations (continued)

## 3 Design Procedure for Current-Mode Type-III Compensation Networks

Using the same design parameters for Figure 1, this section presents the general design procedure for Type-III compensation networks.

 Design the power stage of the switching regulator. In this example, a 3.3-μH inductor and two 100-μF, 6.3-V ceramic capacitors are selected as the output inductor and output capacitors, respectively. See the corresponding data sheet (SLVS949) and design calculator (SLVC219) for the details.

Parameter	Value
Output voltage (VOUT)	3.3 V
Output current (IOUT)	6 A
Input voltage (VIN)	12 V nominal, 8 V to 17 V
Switching frequency (Fsw)	480 kHz

- 2. Determine the crossover frequency fc. It is suggested to choose fc between 70kHz and 130kHz. Generally speaking, the desired fc should be lower for lower output voltage applications because the limited phase boost available from the Type-III compensation network. For details, see Section 5. In this case, fc is selected to be 120 kHz.
- 3. R4 can be determined by



$$R4 = \frac{2\pi \times fc \times VOUT \times Co}{gm_{ea} \times Vref \times gm_{ps}} = \frac{2\pi \times 120kHz \times 3.3V \times (47.6\mu F \times 2)}{1300\mu A/V \times 0.8V \times 16A/V} = 14.2k\Omega \approx 14.3k\Omega \tag{1}$$

Where:

 $gm_{ea}$  – the GM amplifier gain ( 1300  $\mu$ A/V)  $gm_{ps}$  – the power stage gain (16 A/V). Vref – the reference voltage (0.8 V)

In Equation 1, the actual output equivalent capacitance must be used. For ceramic output capacitors, the actual capacitance has to be properly derated according to the applied DC voltage. A simplified derating equation for standard ceramic output capacitor is shown in Equation 2. For more accurate derating models, refer to the manufacturer data sheets for the output capacitors being used.

Co,actual = Co,nominal 
$$\times$$
  $\frac{\text{Vrating} - \text{Vdc}}{\text{Vrating}} = 100 \,\mu\text{F} \times \frac{6.3\text{V} - 3.3\text{V}}{6.3\text{V}} = 47.6\mu\text{F}$  (2)

Where:

Vrating - the voltage rating of the ceramic capacitor

Vdc - the applied DC voltage of the ceramic capacitor

$$C4 = \frac{R_L \times Co}{R4} = \frac{VOUT \times Co}{IOUT \times R4} = \frac{3.3V \times (47.6\mu F \times 2)}{6A \times 14.3k\Omega} = 3.67nF \approx 3.9nF$$
(3)

5. C6 is optional. It can be used to cancel the zero from the ESR (Equivalent Series Resistance) of the output capacitor Co.

$$C6 = \frac{R_{ESR} \times Co}{R4}$$
 (4)

C6 is usually only needed when the ESR zero is less than half of the switching frequency.

$$fesr = \frac{1}{2\pi \times R_{ESR} \times Co} = \frac{1}{2\pi \times 2m\Omega \times (47.6\mu F \times 2)} = 836.3kHz$$
 (5)

In this case, the ESR zero is located at 836.3 kHz, which is greater than Fsw/2 = 240 kHz. So, C6 is not used. C6 is usually not needed for ceramic output capacitors.

6. Cc is selected to provide a zero around the desired crossover frequency (fc) with R8. When using Type-III compensation design, it is convenient to fix R8 value at 10 k $\Omega$  and vary R9 to set the output voltage VOUT.

$$Cc = \frac{1}{2\pi \times R8 \times fc} = \frac{1}{2\pi \times 10k\Omega \times 120kHz} = 132.7pF \approx 150pF$$
 (6)

The complete example design with Type-III compensation is shown in Figure 5.



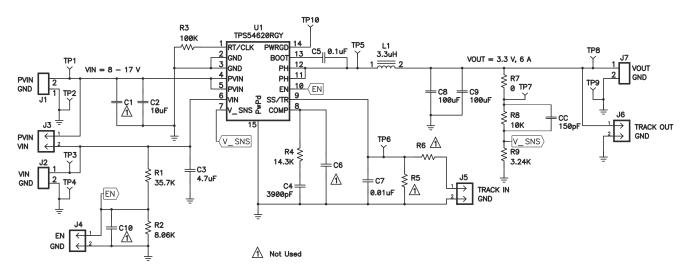


Figure 5. Example Design With Type-III Compensation (Fsw = 480 kHz)

## 4 System Performances for Example Design

Figure 6 shows the loop-response characteristics. Gain and phase plots are shown for Vin = 12 V and Vout = 3.3 V/6 A. The crossover frequency and phase margin are measured at 112 kHz and 60°, respectively.

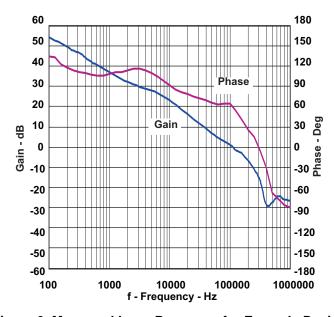


Figure 6. Measured Loop Response for Example Design

Figure 7 shows the response to load transients. The current step is from 25% to 75% of maximum-rated load at VIN = 12 V. Total peak-to-peak voltage variation is as shown, including ripple and noise on the output. Figure 8 shows the transient response for the TPS54620EVM-374 under the same condition. Comparing Figure 7 and Figure 8, the total peak-to-peak voltage variation has been dropped from 50 mV to 25 mV.



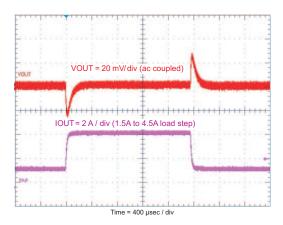


Figure 7. Example Design Transient Response

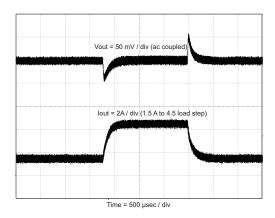


Figure 8. TPS54620EVM-374 Transient Response

#### 5 Limitations for Current-Mode Type-III Compensation Design Procedure

The design procedure described uses simplified equations. It provides starting parameter values for a design. Sometimes, these values may have to be modified to yield the best results.

The Type-III compensation is usually able to boost the system bandwidth above 100 kHz with good phase margin. As the output voltage decreases, the phase boost from Type-III compensation is also reduced. Depending on the application requirements, the improvements on the crossover frequency and phase margin by the Type-III compensation may be limited at low output voltages. Figure 9 provides guidelines on the maximum phase boost that can be obtained from Type-III compensation for popular output voltage range.

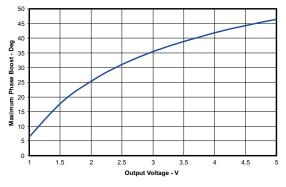


Figure 9. Maximum Phase Boost From Type-III Compensation



Conclusion www.ti.com

## 6 Conclusion

This application report shows an easy way to do Type-III compensation designs for current-mode, step-down DC/DC converters. The experimental measurements also illustrate the improvements of system bandwidth and transient responses by Type-III compensation design.

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